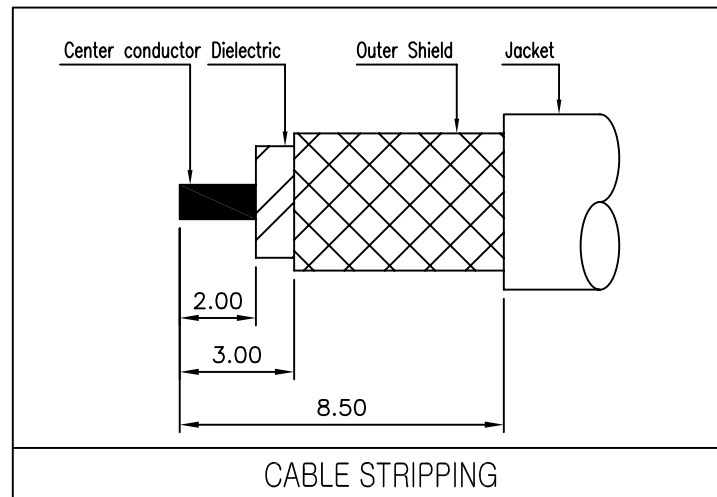
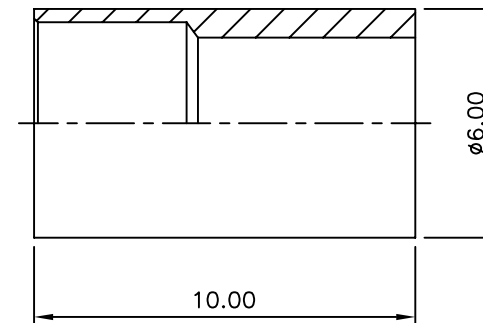
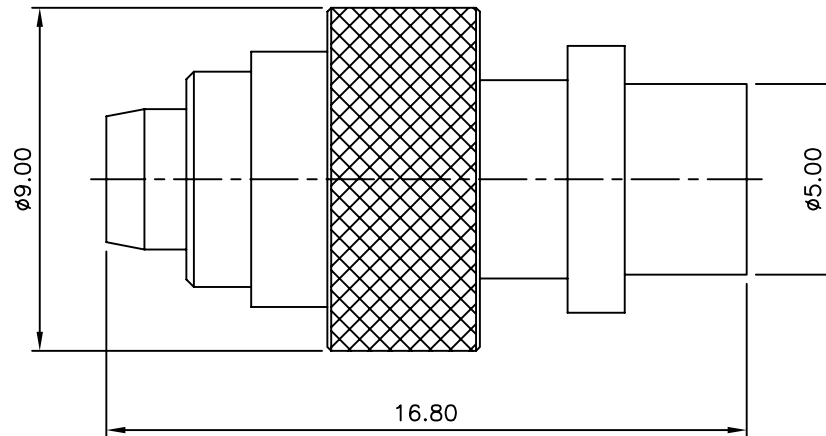


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	E.H.KIM	I.C.KIM	2014.01.03.	
1	[설번처리No.201504-0002] 메이팅부 치수 표준화 적용	H.J.LEE	I.C.KIM	2015. 04. 07.	
2	[설번처리No.201504-0002] 메이팅부 치수 표준화 적용	S.M.LEE	I.C.KIM	2015. 10. 13.	
3	[설번No.201709-0004] PIN MATING부 접촉 개선으로 인한 치수 변경	S.Y.EUN	I.C.KIM	2017. 10. 17.	



7	SPRING	1	SUS	부동태처리	DSR01102-5/1
6	CAP	1	MBsBD	Nickel Plate	DCU02233-5/2
5	INSULATOR	1	TEFLON		DIN02021-N/1
4	FERRULE	1	MBsBD	Nickel Plate	DFE00162-5/1
3	CONTACT	1	MBsBD	Gold Plate	DCT02673-5/1
2	BODY (B)	1	MBsBD	Nickel Plate	DBD03532-5/1
1	BODY (A)	1	MBsBD	Nickel Plate	DBD03160-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 10. 17.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMBL50 CABLE PS MF141
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	A4 DWG NO. CN03150-7/3 REVISION 3 SHEET 1 of 1
		UNIT	mm	